

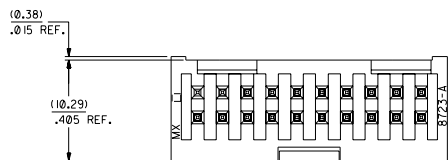
Technical drawing of a selective plate assembly. The drawing shows a cross-section of the assembly with various dimensions and labels.

Labels and dimensions:

- SELECTIVE PLATE AREA**: Points to the top surface of the plate.
- "J" REF.**: Points to the top surface of the plate.
- "K" REF.**: Points to the top surface of the plate.
- SEE NOTE 6**: Points to the top surface of the plate.
- Dimensions**:
 - $(8,00 \pm 0,38) \cdot 315 \pm 0,15$ (Top surface)
 - $(8,89) \cdot 350$ (Bottom surface)
 - $\Phi U | (0,38) \cdot 0,15$ (Left side)
 - $\Phi U | (0,38) \cdot 0,15 | \varnothing$ (Right side)
 - "M" REF.**: Points to the bottom surface of the plate.
 - "L" REF. SELECTIVE PLATE AREA**: Points to the bottom surface of the plate.
 - "P"**: Points to the bottom surface of the plate.
 - [-U-]**: Points to the bottom surface of the plate.

Top view of the component showing dimensions and reference points. The drawing includes the following dimensions and labels:

- Horizontal Dimensions:**
 - Overall width: (1.02) REF.
 - Distance from left edge to center of first row of holes: $(.045)$ REF.
 - Distance between center of first row of holes and center of last row of holes: (2.54) REF. TYP.
 - Distance from center of last row of holes to right edge: $(.090)$ REF. TYP.
 - Distance from left edge to center of first column of holes: $(.14)$ REF.
 - Distance between center of first column of holes and center of last column of holes: (2.54) REF. TYP.
 - Distance from center of last column of holes to right edge: $(.061)$ REF. TYP.
- Vertical Dimensions:**
 - Overall height: $(.280)$ REF.
 - Distance from top edge to center of first row of holes: $(.11)$ REF.
 - Distance between center of first row of holes and center of last row of holes: (2.54) REF. TYP.
 - Distance from center of last row of holes to bottom edge: $(.061)$ REF. TYP.
- Other Labels:**
 - A REF.**: Points to the left edge of the component.
 - B**: Points to the top edge of the component.
 - C**: Points to the right edge of the component.
 - J**: Points to the bottom edge of the component.



- 1- 20 CIRCUIT SIZE SHOWN FOR ILLUSTRATION PURPOSES.
- 2- PIN PUSHOUT FORCE: (17.79 N)/4 LBS.
- 3- PINS MUST MEET SOLDERABILITY SPEC. MIL-STD-202 METHOD 208B.
- 4- WINDOW NOT AVAILABLE ON 6 AND 8 CIRCUIT SIZE.
- 5- FOR CHARTED DIMENSIONS AND ASSEMBLY NO.S NOT SHOWN ON THIS SHEET - SEE SHEET 2.
- 6- ROW TO ROW PIN HEIGHT VARIATION MUST NOT EXCEED (0.131)/.005 IN.
- 7- PRODUCT CONFORMS TO PS-8723.

SHROUDED WAFER: GLASS FILLED POLYESTER, 94V-0; COLOR: BLACK.
PINS: PHOSPHOR BRONZE,
SEE SHEET 2 FOR FINISHES.

[illegible]

